



**T620-600W  
T630-600W**

## SNUBBERLESS TRIAC

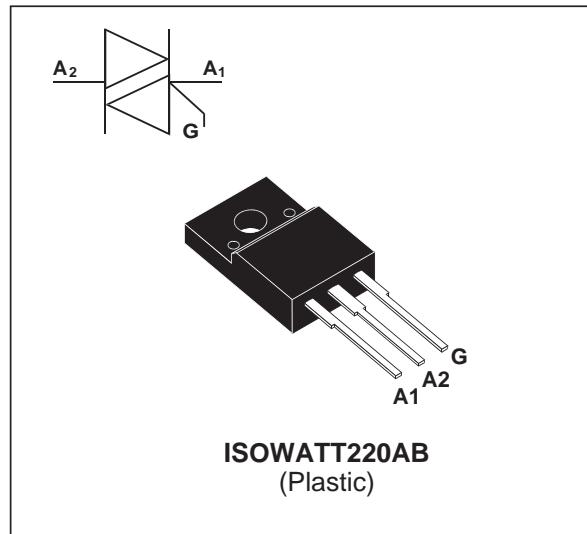
### FEATURES

- $I_{TRMS} = 6A$
- $V_{DRM} = V_{RRM} = 600V$
- EXCELLENT SWITCHING PERFORMANCES
- INSULATING VOLTAGE = 1500V<sub>(RMS)</sub>
- U.L. RECOGNIZED : E81734

### DESCRIPTION

The T620-600W and T630-600W triacs use high performance glass passivated chip technology, housed in a fully molded plastic ISOWATT220AB package.

The SNUBBERLESS™ concept offers suppression of R-C network, and is suitable for applications such as phase control and static switch on inductive and resistive loads.



### ABSOLUTE RATINGS (limiting values)

| Symbol             | Parameter   | Value                                       | Unit                   |
|--------------------|---|---|------------------------|
| $I_{TRMS}$         | RMS on-state current<br>(360° conduction angle)   | 100°C                                       | A                      |
| $I_{TSM}$          | Non repetitive surge peak on-state current<br>( $T_j$ initial = 25°C )  | $t_p = 16.7 \text{ ms}$<br>(1 cycle, 60 Hz) | A                      |
|                    |   | $t_p = 10 \text{ ms}$<br>(1/2 cycle, 50 Hz) | 75                     |
| $I^2t$             | $I^2t$ Value (half-cycle, 50 Hz)  | 10 ms                                       | $\text{A}^2\text{s}$   |
| $dI/dt$            | Critical rate of rise of on-state current<br>Gate supply : $I_G = 500 \text{ mA}$ $dI_G/dt = 1 \text{ A}/\mu\text{s}$ . | Repetitive<br>$F = 50 \text{ Hz}$           | $\text{A}/\mu\text{s}$ |
|                    |   | Non Repetitive                              | 100                    |
| $T_{stg}$<br>$T_j$ | Storage temperature range<br>Operating junction temperature range   | - 40 to + 150<br>- 40 to + 125              | °C                     |
| $T_l$              | Maximum lead temperature for soldering during 10s at 4.5 mm from case   | 260   | °C                     |

| Symbol                 | Parameter  | Value | Unit |
|------------------------|--|-------|------|
| $V_{DRM}$<br>$V_{RRM}$ | Repetitive peak off-state voltage<br>$T_j = 125^\circ\text{C}$ | 600   | V    |

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### THERMAL RESISTANCES

| Symbol               | Parameter  | Value | Unit |
|----------------------|--|-------|------|
| R <sub>th(j-a)</sub> | Junction to ambient                              | 50    | °C/W |
| R <sub>th(j-c)</sub> | Junction to case for A.C (360° conduction angle) | 3.4   | °C/W |

### GATE CHARACTERISTICS (maximum values)

P<sub>G (AV)</sub>= 1 W P<sub>GM</sub> = 10 W (tp = 20 μs) I<sub>GM</sub> = 4 A (tp = 20 μs)

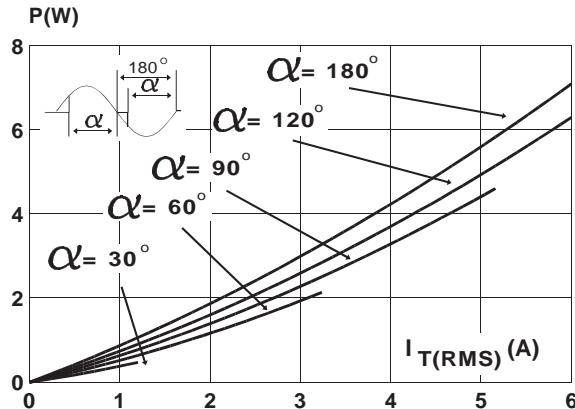
### ELECTRICAL CHARACTERISTICS

| Symbol                               | Test Conditions  | Quadrant               |          | T620 | T630 | Unit |      |
|--------------------------------------|--|------------------------|----------|------|------|------|------|
| I <sub>GT</sub>                      | V <sub>D</sub> =12V (DC) R <sub>L</sub> =33Ω                                       | T <sub>j</sub> = 25°C  | I-II-III | MAX  | 20   | 30   | mA   |
| V <sub>GT</sub>                      | V <sub>D</sub> =12V (DC) R <sub>L</sub> =33Ω                                       | T <sub>j</sub> = 25°C  | I-II-III | MAX  | 1.5  |      | V    |
| V <sub>GD</sub>                      | V <sub>D</sub> =V <sub>DRM</sub> R <sub>L</sub> =3.3kΩ                             | T <sub>j</sub> = 125°C | I-II-III | MIN  | 0.2  |      | V    |
| tgt                                  | V <sub>D</sub> =V <sub>DRM</sub> I <sub>G</sub> = 500mA dI <sub>G</sub> /dt= 3A/μs | T <sub>j</sub> = 25°C  | I-II-III | TYP  | 2    |      | μs   |
| I <sub>H</sub> *                     | I <sub>T</sub> = 100mA Gate open   | T <sub>j</sub> = 25°C  |          | MAX  | 35   | 50   |      |
| V <sub>TM</sub> *                    | I <sub>TM</sub> = 8.5A tp= 380μs   | T <sub>j</sub> = 25°C  |          | MAX  | 1.5  |      | V    |
| I <sub>DRM</sub><br>I <sub>RRM</sub> | V <sub>DRM</sub> rated<br>V <sub>RRM</sub> rated                                   | T <sub>j</sub> = 25°C  |          | MAX  | 10   |      | μA   |
|                                      |  | T <sub>j</sub> = 125°C |          | MAX  | 2    |      | mA   |
| dV/dt *                              | Linear slope up to V <sub>D</sub> =67%V <sub>DRM</sub> Gate open                   | T <sub>j</sub> = 125°C |          | MIN  | 200  | 300  | V/μs |
| (dV/dt)c *                           | (dI/dt)c = 3.3 A/ms (see note)   | T <sub>j</sub> = 125°C |          | MIN  | 10   | 20   | V/μs |

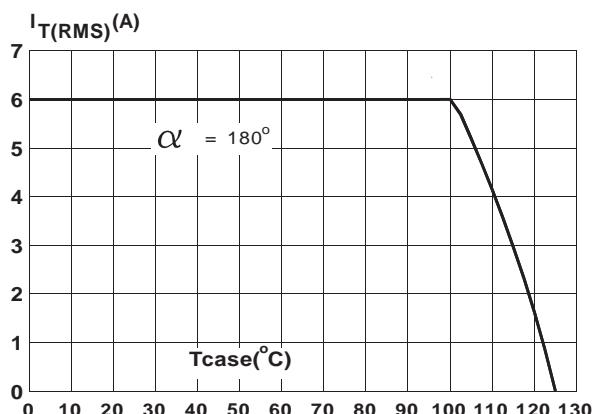
\* For either polarity of electrode A2 voltage with reference to electrode A1.

Note : In usual applications where (dI/dt)c is below 3.3 A/ms, the (dV/dt)c is always lower than 10V/μs, and, therefore, it is unnecessary to use a snubber R-C network across T620W / T630W triacs.

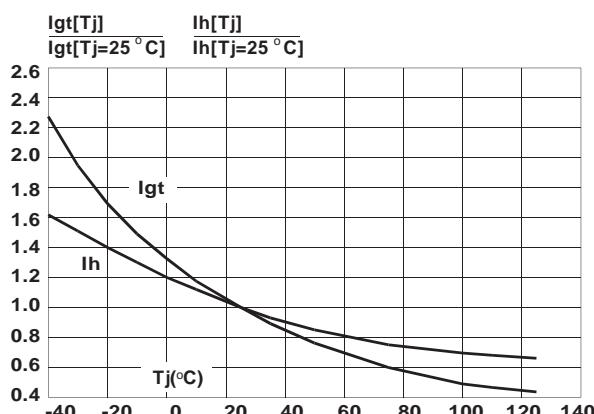
**Fig.1 :** Maximum power dissipation versus RMS on-state current.



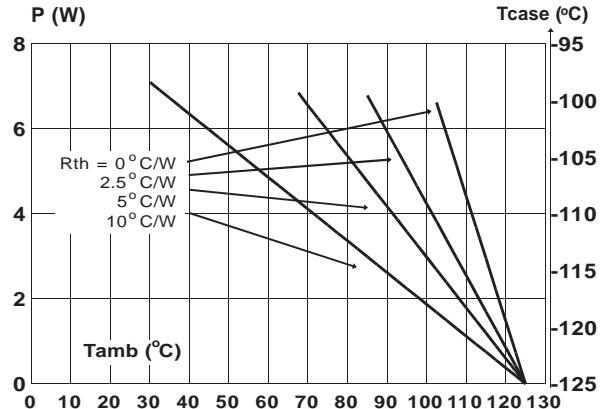
**Fig.3 :** RMS on-state current versus case temperature.



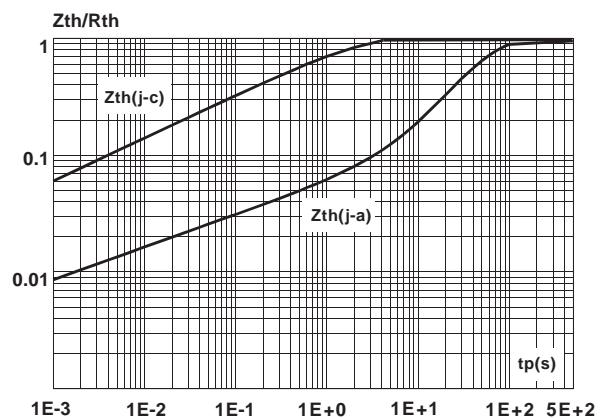
**Fig.5 :** Relative variation of gate trigger current and holding current versus junction temperature.



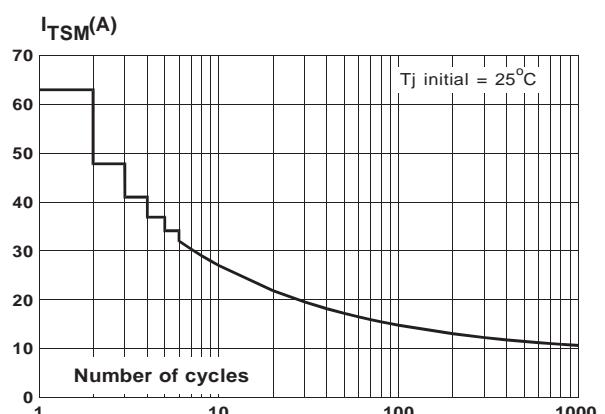
**Fig.2 :** Correlation between maximum power dissipation and maximum allowable temperature (Tamb and Tcase) for different thermal resistances heatsink + contact.



**Fig.4 :** Thermal transient impedance junction to case and junction to ambient versus pulse duration.

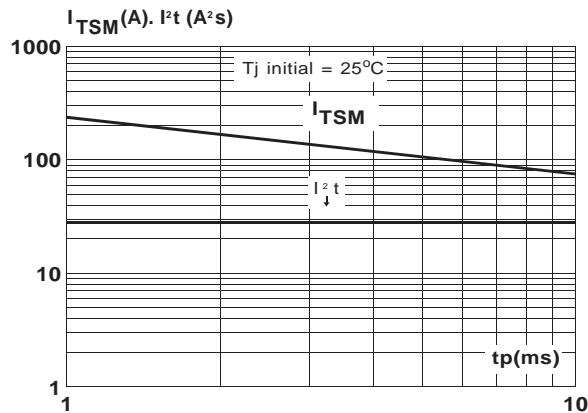


**Fig.6 :** Non repetitive surge peak on-state current versus number of cycles.

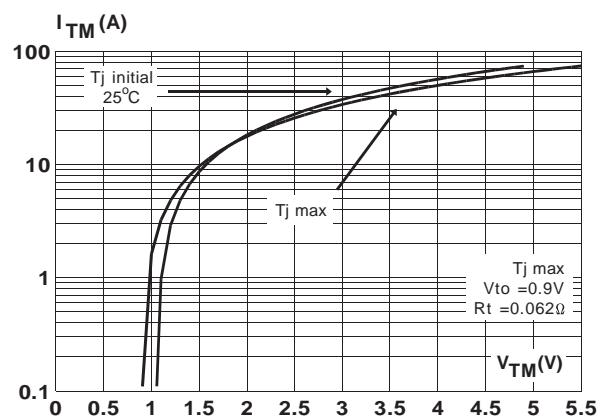


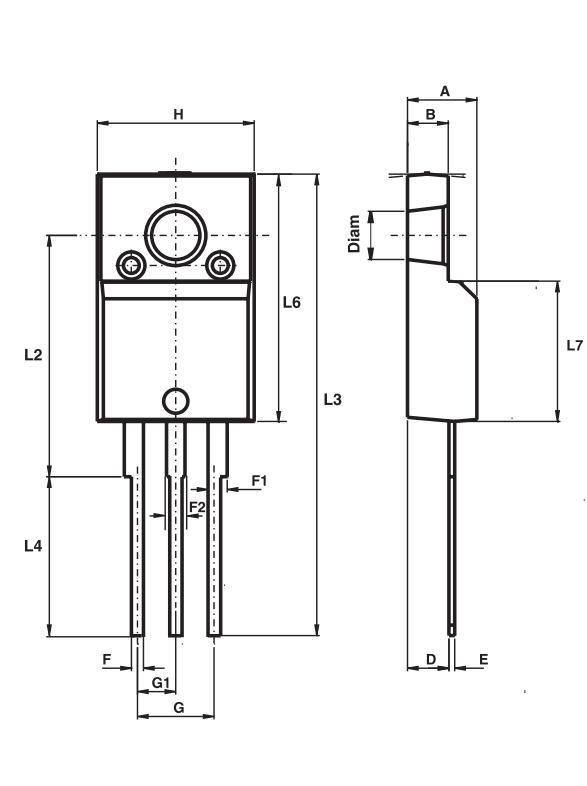
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**Fig.7 :** Non repetitive surge peak on-state current for a sinusoidal pulse with width :  $t_p \geq 10\text{ms}$ , and corresponding value of  $I^2t$ .



**Fig.8 :** On-state characteristics (maximum values).



**PACKAGE MECHANICAL DATA**  
**ISOWATT220AB**


| REF. | DIMENSIONS  |       |            |       |
|------|-------------|-------|------------|-------|
|      | Millimeters |       | Inches     |       |
|      | Min.        | Max.  | Min.       | Max.  |
| A    | 4.40        | 4.60  | 0.173      | 0.181 |
| B    | 2.50        | 2.70  | 0.098      | 0.106 |
| D    | 2.50        | 2.75  | 0.098      | 0.108 |
| E    | 0.40        | 0.70  | 0.016      | 0.028 |
| F    | 0.75        | 1.00  | 0.030      | 0.039 |
| F1   | 1.15        | 1.70  | 0.045      | 0.067 |
| F2   | 1.15        | 1.70  | 0.045      | 0.067 |
| G    | 4.95        | 5.20  | 0.195      | 0.205 |
| G1   | 2.40        | 2.70  | 0.094      | 0.106 |
| H    | 10.00       | 10.40 | 0.394      | 0.409 |
| L2   | 16.00 typ.  |       | 0.630 typ. |       |
| L3   | 28.60       | 30.60 | 1.125      | 1.205 |
| L4   | 9.80        | 10.60 | 0.386      | 0.417 |
| L6   | 15.90       | 16.40 | 0.626      | 0.646 |
| L7   | 9.00        | 9.30  | 0.354      | 0.366 |
| Diam | 3.00        | 3.20  | 0.118      | 0.126 |

- Cooling method : C
- Marking : Type number
- Weight : 2.1g
- Recommended torque value : 0.55 m.N.
- Maximum torque value : 0.70 m.N.

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